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Chapter 3

Recent Advances in BiVO$_4$- and Bi$_2$Te$_3$-Based Materials for High Efficiency-Energy Applications

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Additional information is available at the end of the chapter

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Abstract

This chapter provides recent progress in developments of BiVO$_4$- and Bi$_2$Te$_3$-based materials for high efficiency photoelectrodes and thermoelectric applications. The self-assembling nanostructured BiVO$_4$-based materials and their heterostructures (e.g., WO$_3$/BiVO$_4$) are developed and studied toward high efficiency photoelectrochemical (PEC) water splitting via engineering the crystal and band structures and charge transfer processes across the heteroconjunctions. In addition, crystal and electronic structures, optical properties, and strategies to enhance photoelectrochemical properties of BiVO$_4$ are presented. The nanocrystalline, nanostructured Bi$_2$Te$_3$-based thin films with controlled structure, and morphology for enhanced thermoelectric properties are also reported and discussed in details. We demonstrate that BiVO$_4$-based materials and Bi$_2$Te$_3$-based thin films play significant roles for the developing renewable energy.

Keywords: BiVO$_4$, bismuth telluride (Bi$_2$Te$_3$), photoelectrochemical (PEC) water splitting, thermoelectrics, pulsed laser deposition

1. Bismuth vanadate (BiVO$_4$) material: a highly promising photoanode for use in solar water oxidation

The photoelectrochemical (PEC) water splitting, which uses semiconductors to directly harvest and convert the abundant solar energy into storable and friendly environmental energy in the form of hydrogen and oxygen from water, has been regarded as a promising approach to solve our current energy challenges [1–6]. The PEC cell for energy conversion on a global scale requires the development of devices that are highly efficient, stable, and simple in design. The effective
and economic energy transfer technologies are still under developing stage for more than 40 years. The PEC water splitting becomes more competitive as the cost continues to decrease with the development of nanotechnology, which offers the use of new nano-heterostructure photocatalysts. The current direction along this research field focuses on the development of high efficiency photoelectrodes based on metal oxides due to their high chemical and photostability, low cost, and ease of fabrication. Among these interesting and important photoelectrode materials for PEC, BiVO₄ is demonstrated as a promising photocatalyst for PEC water splitting. Originally, the BiVO₄ was intensively studied as a ferroelasticity, acoustic-optical, and ionic conductivity materials [7]; however, recently most studies focus on its photocatalytic activity owing to its direct bandgap of ~2.5 eV together with the desirable band edges and good stability [8–11]. Additionally, the theoretical solar-to-hydrogen conversion efficiency of the monoclinic BiVO₄ could reach 9.2% with a maximum photocurrent of 7.5 mA cm⁻² under standard AM 1.5 solar light irradiation, which is significantly higher than those of the common metal oxides, and thus the monoclinic BiVO₄ has been recognized as one of the most promising photoanode materials for PEC water splitting [1]. However, its photoactivity performance is limited by its poor electrical conductivity, slow hole transfer kinetics for water oxidation, and poor charge separation [12]. A concise overview of BiVO₄ electronic and optical properties as well as the alternative strategies to improve its photocatalytic activities is discussed in this section.

2. Crystal and electronic structures of bismuth vanadate

The synthesis BiVO₄ crystallizes in three main crystal structures of tetragonal scheelite, monoclinic phase, and tetragonal zircon structure. The photocatalytic activities of BiVO₄ strongly depend on the optical properties of each crystal structure. Among these structures, the monoclinic scheelite BiVO₄ was demonstrated to exhibit the highest photocatalytic water oxidation under visible light illumination [13]. The higher photocatalytic activity of the monoclinic scheelite was attributed to its smaller energy band gap and higher crystal distortion, which enhance the optical absorption and the electron-hole separation [14]. The conduction-band minimum of BiVO₄ is formed mainly by V 3d, which splits into triplet bands V 3d x²−y²/z², V 3d z²/zx, and V 3d zy/xy [15]. The valence band (VB) of tetragonal zircon structure BiVO₄ is formed by O 2p orbital, but the top region of VB of monoclinic structure is formed by both Bi 6s and O 2p orbitals. It was demonstrated that Bi 6s is located above O 2p and the smaller bandgap of monoclinic BiVO₄ attributes to the transition from the 6s electrons of Bi to the 3d orbital of V [14, 16]. Recently, Zou et al. demonstrated that the crystal distortion in monoclinic BiVO₄ improves the lone-pair impact of Bi 6s states which raises up the O 2p states and reduces the bandgap [17]. In addition, the monoclinic scheelite structure possesses the better electron-hole separation owing to its higher degree of structural distortion than that in the tetragonal scheelite structure to result in enhanced photocatalytic activity for the monoclinic structure. In addition, the conduction-band edge of BiVO₄ is only slightly below the H⁺/H₂ redox potential, while its valence band is much below the oxidation potential of water resulting in low required external bias [15].

In order to investigate the experimental crystal and electronic structure of monoclinic BiVO₄, the single crystal BiVO₄, which possesses good crystallinity and eliminates the structural and electronic defects as well as impurity phases, is required. The vacuum deposition such as
sputtering, molecular beam epitaxy, and pulsed laser deposition for the single crystal monoclinic BiVO$_4$ has been developed recently [18–20]. A good lattice match (mismatch less than 1%) of cubic yttrium-stabilized zirconia (YSZ, $a = 5.145$ Å) was used as substrate for epitaxial growth of high-quality epitaxial monoclinic BiVO$_4$ ($a = 5.1935$ Å, $b = 5.0898$ Å, $c = 11.6972$, $\gamma = 90.3871$) films. The X-ray diffraction $\theta$–$2\theta$ scan (Figure 1a) shows only high intensity and sharp (00 l) reflections of monoclinic BiVO$_4$ phase indicating that growth was $c$-axis oriented: BiVO$_4$ (001) $\parallel$ YSZ (001). The high-resolution TEM image (the inset of Figure 1) reveals the

![Figure 1](image1.png)

**Figure 1.** (a) XRD $2\theta$/$\theta$ scans of BiVO$_4$ film grown on YSZ substrate, and the inset shows HR-TEM image of BiVO$_4$; (b) atomic model of BiVO$_4$/YSZ heteroconjunction.

![Figure 2](image2.png)

**Figure 2.** Photoluminescence taken under the irradiation of 325 nm laser at room temperature (green curve) and UV-Vis absorption spectrum (red curve) of BiVO$_4$ epitaxial film.
in-plane and out-of-plane lattice parameters of the BiVO$_4$ with $d_{200} = 2.53$ Å and $d_{002} = 5.81$ Å which are in good agreement with the lattice constants of the bulk monoclinic BiVO$_4$. The orientation and growth direction of BiVO$_4$ crystal were identified and constructed in the corresponding atomic model as shown in Figure 1b.

The electronic structural properties of single crystal BiVO$_4$ were investigated by the photoluminescence (PL) spectroscopy and UV-Visible spectroscopy. Figure 2 presents the PL and UV-Vis absorption spectra of a single crystal BiVO$_4$ film. As presented in the UV-Vis absorption spectrum, the observed absorption in the range of 440–480 nm corresponding to the bandgap of ~ 2.67 eV could attribute to the transition from the 6 s electrons of Bi (or the hybrid orbital of Bi 6 s and O 2p) to the empty 3d $x^2-y^2/z^2$ orbital of V, which is consistent with emission peak of 2.65 eV in the PL spectrum. The second absorption band edge of approximately 3.15 eV and the second PL emission peak at 3.1 eV could be ascribed to the electron transition from O 2p valence band to V 3d $x^2/yz$ and/or V 3d $zy/xy$ orbitals.

3. Strategies to enhance photoelectrochemical properties of BiVO$_4$

The development of suitable techniques to fabricate high efficiency BiVO$_4$ photoelectrode for PEC water splitting is crucial. To date, there are many methods, which have been developed to prepare BiVO$_4$ photoelectrodes for use in solar water oxidation. The representative synthesis methods are (1) metal organic decomposition (MOD) combining with the spin coating or spray pyrolysis deposition [21–23], (2) electrophoretic deposition (EPD) and chemical bath deposition (CBD) [24–27], and (3) vacuum deposition methods such as sputtering deposition and pulsed laser deposition (PLD) [18–20, 28–29]. The MOD is a facile method to synthesize BiVO$_4$ materials for photoelectrodes. The main advantages of the MOD method are the easy composition tuning and morphology engineering. However, the existence of crystal and surface defect and low adhesion between BiVO$_4$ and conducting substrate could limit its performance. The EPD and CBD methods are simple, have low cost, and are easy to scale up. The vacuum deposition is a powerful method to synthesize good crystalline BiVO$_4$ photoelectrodes. The samples prepared by this method could easily control the doped composition; could facilely tune the crystalline in form of amorphous, polycrystalline, and single crystalline; and possess a good adhesion.

As described above, BiVO$_4$ has many advantages features, however, the actual PEC performance of undoped BiVO$_4$ is still far below its theoretical value, indicating that its advantages have not been fully developed. Many research groups have improved photoelectrochemical water oxidation by the introduction of (1) controlled morphologies, (2) forming nanocomposite structure, (3) doping, and (4) decorating with cocatalysts [30]. A summary of advantages and alternative strategies to enhance photoelectrochemical properties of BiVO$_4$ was depicted in Figure 3. The best PEC performance of BiVO$_4$ photoelectrodes that has been demonstrated to date is a combination of several above strategies to take advantages of high surface area, high electron mobility, high water oxidation kinetics, and low charge carrier recombination. Therefore, understanding the benefits and disadvantages of each strategy could provide an effective way to enhance the PEC properties.
First, the morphologies of BiVO$_4$ photoelectrode such as shape, size, and particle contact strongly effect on their interfacial energetics, kinetics, and charge transport properties as well as reactive sites. Because the electrochemical reactions only occur at the electrode-electrolyte interfacial area, the photogenerated electron-hole needs to be transferred to the surface for the reactions. Thus, the development of high surface area photoelectrodes is necessary. The porous structure and one-dimensional nanostructure such as nanorod/nanowire arrays reveal high surface areas per electrode volume, which directly improves the PEC efficiency. The high efficient PEC devices based on the BiVO$_4$ porous structure and the one-dimensional nanostructures have been reported by many research groups [31–34]. However, creating more porosity or smaller nanorod/nanowire structures to improve surface area could increase the defect site, increase grain boundaries, and reduce crystallinity leading reduction photocatalytic activity [35]. In addition, with hole diffusion length of $\sim$100 nm and carrier mobility of $0.044 \ \text{cm}^2\ \text{V}^{-2}\ \text{s}^{-1}$ [36], the length and thickness of nanostructure should be finely optimized to maximize light absorption and photogenerated charge carrier transport. Furthermore, researchers have recently demonstrated that the charge separation and photoactivity properties are closely related to the exposed crystal facet of BiVO$_4$ photocatalysts [8–9, 37–39]. Therefore, an optimized design and morphological control of crystal facets could improve the PEC performance.

Figure 3. The advantages and strategies to enhance photoelectrochemical properties of BiVO$_4$. 

[Diagram showing advantages and strategies to enhance photoelectrochemical properties of BiVO$_4$.]
Second, nanocomposites provide a powerful route to overcome limitations in the current studies of single material systems for water splitting, where the photoelectrochemical performance of photoelectrode can be significantly improved by the choice of proper interactions of constituents. The construction of nanocomposite consisting of BiVO₄ and addition semiconductor/or conductor can improve the optical absorption, charge carrier separation, and charge transport processes. Combination of BiVO₄ with additional metal oxide semiconductors could enhance overall photon absorption and improve electron-hole separation by the rapid photogenerated electron and hole injections at their heterojunctions and extension the optical absorption range. Many BiVO₄-based heterostructures have been fabricated successfully such as TiO₂/BiVO₄, Ag₂PO₄/BiVO₄, Bi₂S₃/BiVO₄, g-C₃N₄/BiVO₄, BiVO₄/SnO₂, WO₃/BiVO₄, BiOCl/BiVO₄, Fe₂O₃/BiVO₄, Cu₂O/BiVO₄, and ZnO/BiVO₄ [40–43]. Among them, the WO₃ is a commonly coupled semiconductor with BiVO₄ because it is a stable n-type semiconductor with better electron transport properties than the BiVO₄ and a suitable conduction-band edge for facile electron injection from conduction band of BiVO₄ [29, 44–46].

Recently, we reported a self-assembled nanocomposite photoanode composed of epitaxial BiVO₄ matrix embedded with WO₃ mesocrystal for photoelectrochemical application in the visible light regime using PLD [29]. By taking the advantage of the structural feature of this heterostructure, the well-defined crystal facet and interface between WO₃ and BiVO₄ phases provide a template for the fundamental understanding of photoactivity in the nanocomposite. The BiVO₄-WO₃ crystal structure details were investigated by XRD and TEM as shown in Figure 4. The XRD 2θ-θ scans, in-plane Φ-scans, and reciprocal space map results clearly show that BiVO₄ and WO₃ spontaneously separated into two phases during the deposition with an in-plane orientation relationship as [100]BiVO₄//[110]WO₃//[001]WGC. Both monoclinic WO₃ and orthorhombic BiVO₄ phases exhibit two sets of structural domains, which are separated by a 90° rotation around c-axis. The microstructure and the epitaxial relationship of BiVO₄-WO₃ heterostructure were further investigated as displayed in Figure 4(b–e), which are in an excellent agreement with the XRD analyses. The self-assembled mesocrystal-embedded heterostructure that composed WO₃ and BiVO₄ phases is illustrated in Figure 4g. The energy band alignment of BiVO₄-WO₃ heterojunction illustrated using X-ray photoelectron spectroscopy technique shows that the valence band maxima of WO₃ lies 0.55 eV below that of BiVO₄ and the conduction-band minimum of WO₃ lies 0.25 eV below that of BiVO₄. This energy band structure could favor the enhancement of photogenerated charge carrier separation, which was further confirmed by photoluminescence and ultrafast transient absorption spectroscopies. Figure 5 shows Nyquist electrochemical impedance spectroscopy and Mott-Schottky analysis for the BiVO₄-WO₃ photoelectrodes. The results demonstrated a much higher electron conductivity of WO₃ with carrier densities of \(9.68 \times 10^{18}\) cm\(^{-3}\) under light illumination than BiVO₄. Therefore, the BiVO₄ matrix serves as the light absorber due to its narrow bandgap, and the WO₃ mesocrystal acts as an electron conductor owing to its high electron conductivity resulting in a significantly enhanced photoelectrochemical performance.

Further example could be observed in the double-deck inverse opal WO₃/BiVO₄ structure that could reach a photocurrent density of 3.3 mA/cm\(^{2}\) at 1.23 V versus RHE and the core-shell WO₃/BiVO₄ helix nanostructure, in which BiVO₄ was doped with Mo and naturally doped with W from the WO₃ core, exhibits a high photocurrent density of 3.6 mA/cm\(^{2}\) at 1.23 V versus RHE [34, 47]. More recently, the highest photocurrent density of 6.72 mA/cm\(^{2}\) at 1.23 V versus RHE for
Figure 4. Structure characterization of BiVO$_4$-WO$_3$ nanocomposite. (a) X-ray diffraction 2θ-θ scans of pure WO$_3$, BiVO$_4$, and the BiVO$_4$-WO$_3$ nanocomposite showing only (00$l$) type peaks of BiVO$_4$ and WO$_3$. Inset shows XRD ϕ-scans of YSZ (220), BiVO$_4$ (013), and WO$_3$ (022) reflections for BiVO$_4$-WO$_3$ heterostructure. (b-e) Cross-sectional TEM images of BiVO$_4$-WO$_3$ (BVO-WO) nanocomposite taken along [010]$_{YSZ}$ zone axis. The enlarged images taken from the marked areas of (d) BiVO$_4$ and (e) WO$_3$ showing their out-of-plane and in-plane d-spacing parameters. (f) X-ray reciprocal space maps (RSMs) of the composite grown on ITO/YSZ. (g) Illustration of self-assembled BiVO$_4$-WO$_3$ nanocomposite [29].

Figure 5. (a) The Nyquist plots and (b) the Mott-Schottky plots for the WO$_3$, BiVO$_4$, and BiVO$_4$-WO$_3$ photoelectrodes in 0.5 M Na$_2$SO$_4$ solution under AM 1.5 illumination [29].
BiVO₄-based photoelectrode was obtained in the CoPi-coated WO₃/BiVO₄ core-shell nanorods [21]. The high efficiency photoelectrode was attributed to the superior charge carrier separation and efficient light scattering. In addition, by coupling with a conductor such as reduced graphene oxide and carbon nanotubes, the photocurrent density of the composite electrodes was improved significantly compared to those of the corresponding BiVO₄ electrodes which could attribute to the enhancement of charge separation and transport properties [49–57]. However, due to the low crystallinity of BiVO₄ as well as the poor BiVO₄-conductor and conductor-substrate contact in these nanocomposites, it needs to be further developed to improve the PEC performance.

Third, doping with the metal (such as W, Fe, B, Cu, Zn, Ti, Nb, Sn, Co, Pd, Rh, Ru, Ag, Ga, Sr, and Ir) or nonmetal (such as P and N) materials can change the electrical and optical properties of BiVO₄. Among them, only Mo- and W-doped BiVO₄ show a significantly enhanced photocurrent and IPCE [21]. The intentional introduction of n-type conductivity W and/or Mo atoms does not change the bandgap energy and band edge positions of doped-BiVO₄; however, it can increase the charge carrier density and the electrical conductivity. A suitable doping concentration of Mo and/or W results in significant improvement PEC performance of BiVO₄ [54–56]. On the other hand, P doping forms an internal electric field which may improve the photogenerated electron–hole separation. However, it is noted that the doping could induce trap carrier which can enhance charge carrier recombination and reduce the charge transport [35]. Therefore, the optimum doping concentration is a key factor to improve the overall PEC performance of the photoelectrode.

Finally, decoration of BiVO₄ with various oxygen evolution catalysts (OECs) such as Co–Pi, Co₃O₄, RhO₂, Pt, CoO, and FeOOH improves the kinetic for oxygen evolution and provides unique active sites for catalytic reactions, thereby strongly enhanced the photocurrent density [3, 27, 40, 57–58]. In addition, it decreases the bias potential and improves the stability of BiVO₄ photoanodes. Perhaps the most successful route in the development of high efficient BiVO₄ photoelectrode for water oxidation is the modification of the BiVO₄-semiconductor nanocomposite surface with OECs. To date, the highest photocurrent density 6.72 mA/cm² at 1.23 V versus RHE was obtained for the CoPi-coated WO₃/BiVO₄ core-shell nanorods [48].

4. Introduction to thermoelectric bismuth-based materials and applications

Thermoelectric (TE) materials are used in appliances such as heat pumps and power generators [59–63]. TE devices offer unique features of low environmental impact, no moving parts, quiet operation, and high reliability. The performance of TE materials is determined by a dimensionless figure of merit, \( ZT = \alpha^2 \sigma T/\kappa \), in which \( \alpha \), \( \sigma \), \( T \), and \( \kappa \) are the Seebeck coefficient, the electrical conductivity, absolute temperature, and the thermal conductivity, respectively. A TE material must exhibit a high power factor (PF = \( \alpha^2 \sigma \)) and low thermal conductivity (\( \kappa \)) to achieve a high ZT value. However, it is challenging for enhancing the ZT value due to the coupling among the TE parameters [62]: the relationship between \( \alpha \) and the carrier concentration \( n \) (expressed by \( |\alpha| \propto n^{2/3} \) approximately [60]) limits the increase of the PF (\( \propto \alpha^2 \sigma \)), while the proportional relationship between electrical conductivity and electronic thermal conductivity (the Wiedemann-Franz law) restricts the enhancement of the \( \sigma/\kappa \) ratio.
Bismuth (Bi)-based chalcogenide narrow-bandgap semiconductors such as Bi$_2$Te$_3$, Bi$_2$Se$_3$, Sb$_2$Te$_3$, Bi$_x$(Te$_{2x-1}$Se$_x$)$_3$, and (Bi$_x$Sb$_{1-x}$)$_3$Te$_2$ are of high interest [64–69]. They have been widely exploited for Peltier coolers and thermoelectric generators at low temperature regime (≤150°C) [70, 71]. Thanks to the extensive phonon scattering at grain boundaries, nanocrystalline and nanostructured Bi-based chalcogenide thin films have achieved reduced thermal conductivity [72–77]. However, the lattice imperfections and grain-boundary defects impair the electrical transport properties of the films [72], which call for further investigations to improve PF or the electronic part of ZT. Currently, enhancing the PF of Bi-based thin films is challenging due to not only the coupling among TE material properties [60] but also the tendency of forming nonstoichiometric films at elevated substrate temperatures (T) [78]. Numerous charge carriers arising from vacancy defects of volatile elements can constrain the enhancement of αT; however, low carrier concentrations can suppress electrical conductivity if carrier mobility (μ) is poor.

The crystal structures of Bi$_2$Se$_3$ and Bi$_2$Te$_3$ are usually described by a hexagonal cell that consists of 15 layers of atoms stacking along the c-axis with a sequence shown below [60], as shown in Figure 6. The five-atomic-layer thick lamellae of ...Te$\cdots$Te accounts for the easy cleavage of these materials perpendicular to the c-axis and the anisotropic thermal and electrical transport properties. For example, the thermal conductivity along the c-axis direction is ~0.7 Wm$^{-1}$K$^{-1}$, while it is ~1.5 Wm$^{-1}$K$^{-1}$ for the plane perpendicular to the c-axis [79].

Thin-film technology is advantageous for obtaining nanocrystalline and nanostructured materials by adjusting deposition conditions and subsequent thermal treatments. The extensive phonon scattering at grain boundaries in the nanostructures causes a large reduction in thermal conductivity while maintaining reasonable electrical conductivity, leading to enhanced ZT. Among physical vapor deposition techniques, PLD offers a great versatility in thermal conductivity while maintaining reasonable electrical conductivity, leading to enhanced ZT. Recent Advances in BiVO$_4$ and Bi$_2$Te$_3$-Based Materials for High Efficiency-Energy Applications

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First, a thin-film device has the natural advantage of a small volume (thickness of ≤10 μm, length and width of ~100 μm) as compared to size of millimeters for a bulk TE couple. As a result, thin-film TE cooling can be integrated into microelectronic systems (Figure 7a). In principle, the bulk device can be scaled down to micro sizes; however, fabrication processes to do so are difficult.

Second, thin-film devices have a much shorter response time than bulk devices, as shown in Figure 7c [39]. The thin-film device achieves the steady state in 15 μs, while the bulk device requires 0.35 s [59]. This is a result of the response time associated with the transport of heat through the thin film (micrometers) rather than through the millimeters associated with bulk devices.

Third, the thin-film device has the ability to handle much larger density of heat pumping power than does the bulk device. Typically, bulk devices are working with pumping power
Figure 6. The hexagonal structures of one unit cell of Bi$_2$Se$_3$ and Bi$_2$Te$_3$. 
density lower than 10 W/cm\(^2\); however, the pumping power density in a thin-film device is on the order of hundreds of W/cm\(^2\) [82]. Figure 7d illustrates a comparison performance chart between thin-film and bulk TE modules, in which the load line represents the temperature difference (\(\Delta T\)) between the top and bottom substrate and possible pumping power density (\(Q\)) for a given drive current of a TE module [83]. At the maximum drive current for a TE module, the load line is determined by the maximum power density (\(Q_{\text{max}}\)) and the \(\Delta T_{\text{max}}\). For a commercial example, under a given drive current, an eTEC™ Series thin-film TE module (Laird technology) possesses a larger pumping power up to ten times (Figure 7e) and a comparable maximum temperature difference \(\Delta T_{\text{max}}\) than the conventional bulk TE modules [83].

Fourth, the granular structure-morphology of thin films increases the grain-boundary scattering which is helpful for suppressing \(\kappa\) and enhanced \(ZT\) values. Figure 7b represents the roles of grain orientation and grain size in carrier mobility. The grains with the same colors illustrate that they have the same/similar orientations. The grain-boundary scattering in

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**Figure 7.** (a) An example for optoelectronics of the continuing reduction in package size. (b) A schematic of grain-boundary scattering for thin-film materials with (i) disoriented-small grains and (ii) highly oriented large grains. (c) The comparison of thermal/cooling time response of thin-film (~5 μm) superlattice device and a bulk device [59]. (d) Thermoelectric module performance chart which presents the temperature drop \(\Delta T\) versus pumping power [83]. (e) A commercial thin-film TE module. (f) Size comparison between a thin-film TE device and bulk TE device [83].
**Figure 7b(i)** will be greater than that of the **Figure 7b(ii)** case because of its smaller grain size and the greater grain disorientation. The effective mobility is given by \[ \mu_e = \frac{L_q}{\sqrt{2\pi m^* kT}} \exp\left(-\frac{\phi_b}{kT}\right) \] (1)

where \( q \) is the carrier charge, \( m^* \) is the effective mass, \( k \) is the Boltzmann constant, \( T \) is the temperature, and \( \phi_b \) is the grain-boundary potential barrier in the depletion region. In polycrystalline silicon, the potential barrier height is approximately twice as high at random boundaries as at low-energy coincidence boundaries.

### 5. Thermoelectric properties of nanocrystalline and nanostructured Bi\(_2\)Te\(_3\)-based thin films

Thermoelectric Bi\(_2\)Te\(_3\)-based materials have played a dominant role in the field of thermoelectrics. The traditional cooling materials are alloys of Bi\(_2\)Te\(_3\) with Sb\(_2\)Te\(_3\) (such as Bi\(_{0.5}\)Sb\(_{1.5}\)Te\(_3\); p-type) and of Bi\(_2\)Te\(_3\) with Bi\(_2\)Se\(_3\) (such as Bi\(_2\)Te\(_{2.7}\)Se\(_{0.3}\); n-type), with a ZT at room temperature approximately equal to one [63]. Recently, nanocrystalline and nanostructured Bi\(_2\)Te\(_3\)-based thin films have recently attracted great interests because of their superior TE performance [72–77, 80, 81, 85, 86]. The PF of Bi\(_2\)Te\(_3\) films was 8.8 \( \mu \)Wcm\(^{-1}\) K\(^{-2}\) for an (015)-oriented film with layered-hexagonal morphology [85] and 33.7 \( \mu \)Wcm\(^{-1}\) K\(^{-2}\) for a highly (00l)-oriented layered film [86]. Furthermore, the hexagonal-Bi\(_2\)Te\(_3\) film grown using MBE obtained a PF of 27 \( \mu \)Wcm\(^{-1}\) K\(^{-2}\) [87], and the smooth-epitaxial Bi\(_2\)Te\(_3\) film prepared by co-evaporation achieved a PF of 39.9 \( \mu \)Wcm\(^{-1}\) K\(^{-2}\) [88].

Despite fewer studies performed on thermoelectric Bi\(_2\)Se\(_3\) as compared to Bi\(_2\)Te\(_3\), a considerable amount of recent efforts to enhance TE performance has been devoted to the synthesis of Bi\(_2\)Se\(_3\) nanostructures such as hexagonal flakes (PF \( \approx 0.28 \) \( \mu \)Wcm\(^{-1}\) K\(^{-2}\)) [89] and nanoflakes (PF \( \approx 0.97 \) \( \mu \)Wcm\(^{-1}\) K\(^{-2}\)) [90], using the solvo-thermal method and chemical bath deposition, respectively. Moreover, the Bi\(_2\)Se\(_3\) film grown by metal organic-chemical vapor deposition has reached a PF \( \approx 5.8 \) \( \mu \)Wcm\(^{-1}\) K\(^{-2}\) [91]. In PLD, tightly controlling substrate temperatures (\( T \)
and ambient pressures enable the morphologies and compositions of films to be manipulated extensively, which offer a new method for enhancing the TE properties of films. For example, self-assembled Bi$_2$Te$_3$ films featuring well-aligned zero- to three-dimensional nanoblocks have been fabricated (Figure 8), but the room temperature PFs of these films remain low ($\leq 1.9 \mu\text{Wcm}^{-1}\text{K}^{-2}$) due to the low electrical conductivity of the voided structures [77].

Figure 9. The morphology and power factor (PF, unit $\mu\text{Wcm}^{-1}\text{K}^{-2}$) of the optimal Bi$_2$Te$_3$ and Bi$_2$Se$_3$ thin films with layered structures grown by PLD, reported in Refs. [66, 67, 80, 86].
By contrast, the Bi$_2$Te$_3$-based thin films with compact and/or layered structures possess the high electrical conductivities and relatively high Seebeck values if the films obtain stoichiometry. For example, A. Li Bassi et al. reported a high PF of 50.6 μW cm$^{-1}$ K$^{-2}$ for the layered-smooth Bi$_2$Te$_3$ films (Figure 9a) [80]. Similarly, the Bi$_2$Te$_3$ films with layered-hexagonal grain structure exhibited a high PF of 33.7 μW cm$^{-1}$ K$^{-2}$ (Figure 9b) [86]. P.H. Le et al. found that the optimal PF films also present compact-layered structures, namely, PF = 24.3 μW cm$^{-1}$ K$^{-2}$ for the Bi$_2$Te$_3$ film (Figure 9c) and PF = 5.54 μW cm$^{-1}$ K$^{-2}$ for the hexagonal Bi$_2$Se$_3$ film (Figure 9d) [66, 67]. Usually, compact or layered structure films obtain high carrier mobility than those with the open/voided nanostructures.

Table 1 summarizes thermal transport properties (at room temperature) of nanocrystalline-nanostructured Bi$_2$Te$_3$-based thin films and bulk materials in the literature [62, 72–76, 87, 92].

<table>
<thead>
<tr>
<th>Sample, fabrication method</th>
<th>Avg. grain size</th>
<th>κ (W/m K)</th>
<th>σ (S/cm)</th>
<th>α (μV/K)</th>
<th>PF = σα$^2$ (μW/cmK$^2$)</th>
<th>ZT (300 K)</th>
<th>Ref.</th>
</tr>
</thead>
<tbody>
<tr>
<td>Bi$<em>2$Te$</em>{2.7}$Se$_{0.3}$ nanocrystalline thin film, flash evaporation</td>
<td>60 nm</td>
<td>0.8 (cross-plane)</td>
<td>540</td>
<td>-186.1(in-plane)</td>
<td>18.7(in-plane)</td>
<td>0.7</td>
<td>[72]</td>
</tr>
<tr>
<td>Sintered bulk Bi$<em>2$Te$</em>{2.7}$Se$_{0.3}$ material, hot pressing</td>
<td>30 μm</td>
<td>1.6</td>
<td>930</td>
<td>-177.5</td>
<td>29.3</td>
<td>0.6</td>
<td></td>
</tr>
<tr>
<td>Nanocrystalline bismuth-telluride-based (Bi$<em>2$Te$</em>{2.7}$Se$_{0.3}$) thin film</td>
<td>10 nm</td>
<td>0.61</td>
<td>550</td>
<td>-84.0</td>
<td>3.9</td>
<td>0.19</td>
<td>[73]</td>
</tr>
<tr>
<td></td>
<td>27 nm</td>
<td>0.68</td>
<td>540</td>
<td>-138.1</td>
<td>10.3</td>
<td>0.46</td>
<td></td>
</tr>
<tr>
<td></td>
<td>60 nm</td>
<td>0.80</td>
<td>540</td>
<td>-186.1</td>
<td>18.7</td>
<td>0.70</td>
<td></td>
</tr>
<tr>
<td>Nanocrystalline Bi-Sb-Te thin film, sputtering</td>
<td>26 nm</td>
<td>0.46</td>
<td>3.3</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>[75]</td>
</tr>
<tr>
<td></td>
<td>45 nm</td>
<td>0.65</td>
<td>6.7</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td></td>
</tr>
<tr>
<td></td>
<td>84 nm</td>
<td>0.81</td>
<td>33.3</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td></td>
</tr>
<tr>
<td>Nanocrystalline Bi$_2$SeTe$_3$ (8:3:6) thin film, flash evaporation</td>
<td>150 nm</td>
<td>0.6</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>[74]</td>
</tr>
<tr>
<td>Single crystal Bi$_2$SeTe$_3$ bulk alloys</td>
<td>-</td>
<td>0.75</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>[62]</td>
</tr>
<tr>
<td>Bi$<em>2$Te$</em>{1.4}$Sb$_{0.6}$Te$_3$ superlattices (period ~5 nm)</td>
<td>-</td>
<td>0.4</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>[93]</td>
</tr>
<tr>
<td>Bi$<em>2$Te$</em>{1.4}$Sb$_{2}$Te$_3$ bulk</td>
<td>-</td>
<td>2.2</td>
<td>1000</td>
<td>-240</td>
<td>58</td>
<td>0.87</td>
<td>[62]</td>
</tr>
<tr>
<td>Bi$<em>2$Te$</em>{1.4}$Sb$_{2}$Te$_3$ superlattice film, MBE</td>
<td>-</td>
<td>1.59</td>
<td>901</td>
<td>-223</td>
<td>45</td>
<td>0.85</td>
<td>[62]</td>
</tr>
<tr>
<td>Bi$_2$Te$<em>3$/Bi$<em>2$Te$</em>{1.8}$Se$</em>{0.2}$ superlattice film, MBE</td>
<td>80 nm</td>
<td>1.25</td>
<td>639</td>
<td>-204</td>
<td>27</td>
<td>0.60</td>
<td>[87]</td>
</tr>
<tr>
<td>Bi$_2$Te$_3$ films, laser ablation</td>
<td>-</td>
<td>0.2-0.3</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>[92]</td>
</tr>
<tr>
<td>Bi$_2$Te$_3$/Bi$_2$Se$_3$ nanolayer film, PLD</td>
<td>190 nm</td>
<td>1.16</td>
<td>2700</td>
<td>95</td>
<td>25</td>
<td>0.65</td>
<td>[76]</td>
</tr>
<tr>
<td>Bi$_2$Te$_3$/Bi$_2$Se$_3$ nanodisk film, PLD</td>
<td>100 nm</td>
<td>1.00</td>
<td>1100</td>
<td>132</td>
<td>20</td>
<td>0.60</td>
<td></td>
</tr>
<tr>
<td>Bi$_2$Te$_3$/Bi$_2$Se$_3$ nanocolumn film, PLD</td>
<td>70 nm</td>
<td>0.93</td>
<td>280</td>
<td>207</td>
<td>12</td>
<td>0.39</td>
<td></td>
</tr>
</tbody>
</table>

Table 1. Room temperature thermal transport properties of nanocrystalline-nanostructured Bi$_2$Te$_3$-based thin films and bulk materials in the literature, including sample and fabrication method, average grain size, thermal conductivity κ, electrical conductivity σ, Seebeck coefficient α, power factor PF (= ασ), and ZT (at 300 K).
Generally, the thermal conductivity $\kappa$ value for polycrystalline films is expected to be smaller than that of bulk alloys because of the contribution of grain-boundary scattering $[62, 72, 74]$. Moreover, the $\kappa$ of nanocrystalline Bi$_{2}$Te$_{3}$-based films will further decrease when the grain size of decreases ($\kappa \leq 0.81$ W/mK) $[73, 75]$. For Bi$_{2}$Te$_{3}$/Sb$_{2}$Te$_{3}$ superlattice films, the coherent backscattering of phonon waves at the superlattice interfaces is outlined for the reduction of lattice thermal conductivity, resulting in the low $\kappa \leq 0.4$ W/mK $[93]$.

For PLD Bi$_{2}$Te$_{3}$-based films, Walachova et al. $[92]$ estimated $\kappa$ starting from direct ZT measurement with the Harman method and found a value of about 0.2–0.3 W/mK for films with a thickness comparable to our films (>100 nm). Recently, Chang et al. $[76]$ reported the $\kappa$ between 0.93 and 1.16 W/mK for granular Bi$_{x}$Sb$_{2-x}$Te$_{3}$ films. The reported $\kappa$ (at 300 K) of hexagonal flake Bi$_{2}$Se$_{3}$ was 0.75 W/mK.

6. Conclusion

We report the crystal, electronic structures, optical properties, and PEC activities of BiVO$_{4}$-based materials. Morphology engineering, cocatalyst loading, and doping with metal and nonmetal composite structures are the approaches to fabricate high efficiency BiVO$_{4}$ photoelectrode for PEC water spitting. In addition, the Bi$_{2}$Te$_{3}$-based thin films with nanocrystalline and nanostructured morphologies obtain the reduced thermal conductivity, meanwhile the close stoichiometric films with layered structure morphologies exhibit high thermoelectric power factors. BiVO$_{4}$-based materials and Bi$_{2}$Te$_{3}$-based thin films play significant roles for the photoelectrode and thermoelectric applications.

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